# **PACKAGING INFORMATION**

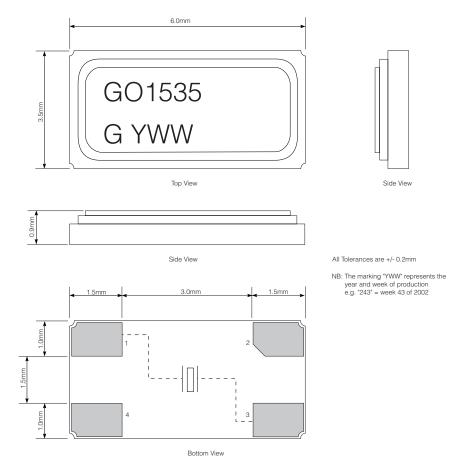
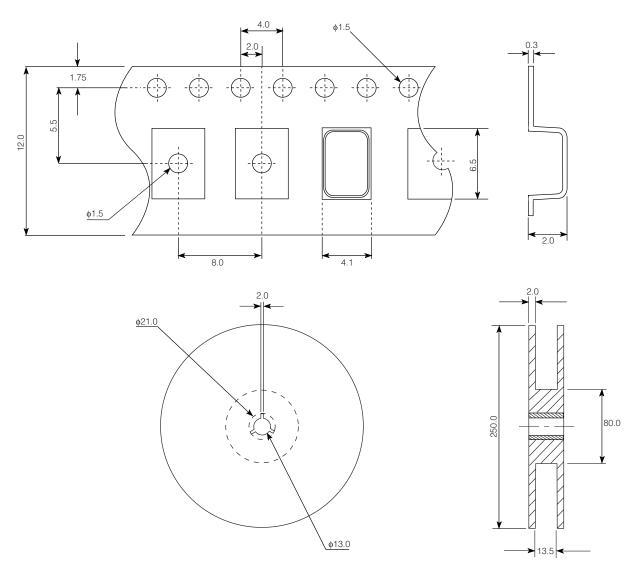


Fig. 2 Package Dimensions

# **PACKAGING INFORMATION (CONTINUED)**



Note: All Dimensions in Millimeters. 500 Pieces per Reel.

Fig. 3 Tape and Reel Dimensions

# **SOLDER REFLOW PROFILES**

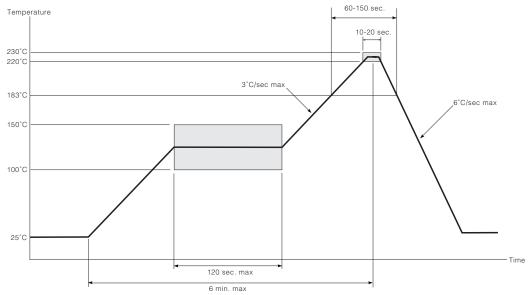


Fig. 4 Standard Eutectic Solder Reflow Profile

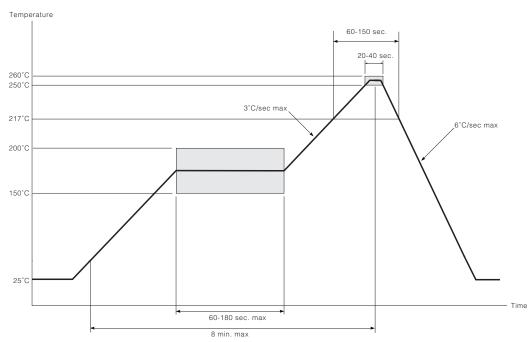


Fig. 5 Maximum Pb-free Solder Reflow Profile

### **CAUTION**

ELECTROSTATIC SENSITIVE DEVICES

DO NOT OPEN PACKAGES OR HANDLE EXCEPT AT A STATIC-FREE WORKSTATION



### DOCUMENT IDENTIFICATION

DATA SHEET

The product is in production. Gennum reserves the right to make changes at any time to improve reliability, function or design, in order to provide the best product possible.

MAILING ADDRESS:

**GENNUM CORPORATION** 

P.O. Box 489, Stn. A, Burlington, Ontario, Canada L7R 3Y3 Tel. +1 (905) 632-2996 Fax. +1 (905) 632-5946

SHIPPING ADDRESS:

970 Fraser Drive, Burlington, Ontario, Canada L7L 5P5

#### **REVISION NOTES:**

Updated packages to reflect E3 packaging. Added 'Pb-free' bullet on front page. Added Pb-free solder reflow profile.

GENNUM JAPAN CORPORATION

Shinjuku Green Tower Building 27F, 6-14-1, Nishi Shinjuku, Shinjuku-ku, Tokyo, 160-0023 Japan

Tel. +81 (03) 3349-5501, Fax. +81 (03) 3349-5505

GENNUM UK LIMITED

25 Long Garden Walk, Farnham, Surrey, England GU9 7HX Tel. +44 (0)1252 747 000 Fax +44 (0)1252 726 523

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> 5 of 5 25122 - 4